

FB220LM~FB230LM

SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

REVERSE VOLTAGE - 20 to 30 Volts FORWARD CURRENT - 2.0 Ampere

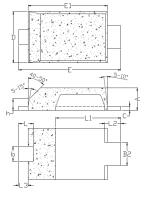
FEATURES

- Very low profile package 0.80mm
- · High efficiency
- · Extremely fast switching
- Negligible switching losses
- · Low forward voltage drop, low power loss

MECHANICAL DATA

- Case: JEDEC DO-222AA
- Case Material: "Green" molding compound, UL flammability classification 94V-0, (No Br. Sb. Cl.)
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Lead Free Plating (Matte Tin Finish.)
- Component in accordance to RoHs 2002/95/EC

Mite Flat



DO-222AA						
DIM.	MIN.	MAX.				
Α	0.80	0.95				
b	0.40	0.65				
b2	0.70	1.00				
O	0.10	0.25				
D	1.75	2.05				
Е	3.60	3.90				
E1	2.80	3.10				
h	0.35	0.50				
L	0.50	0.80				
L1	2.10	2.60				
L2	0.45	0.75				
L3	0.20	0.50				
All Dimension in millimeter						

CATHODE ANODE TAB 1

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

PARAMETER			SYMBOL	FB220LM	FB230LM	UNIT	
Device marking code			Note	B2D	B2E		
Maximum Repetitive Peak Reverse Voltage			V _{RRM}	20	30	V	
Maximum RMS Voltage			V _{RMS}	14	21	V	
Maximum DC Blocking Voltage			V_{DC}	20	30	V	
Average Rectified Output Current @T _L =110°C		I _(AV)	2.0		А		
Peak Forward Surge Current 8.3ms single half sine-wave		I _{FSM}	50		Α		
Operating junction temperature range			TJ	-55 to +125		°C	
Storage temperature range		T _{STG}	-55 to +150		°C		
PARAMETER	TEST CO	NDITIONS	SYMBOL	Min.	Max.	UNIT	
Forward Voltage (1)	IF=2.0A	Tj=25°C	V _F		0.44	V	
Leakage Current (1)	VR= V _{DC}	Tj=25°C Tj=80°C	I _R		0.4 15	mA	
THERMAL CHARACTERISTIC		SYMBOL	Тур	Typical			
Typical junction capacitance (2)			CJ	120		pF	
Typical thermal resistance _ Junction to Case (3)			R⊕ _{JC}	22		°C/W	
Typical thermal resistance _ Junction to Ambient (3)			R⊖ _{JA}	60		°C/W	
Typical thermal resistance _ Junction to Lead (3)			R⊕JL	18		°C/W	
Note:					REV. 2, Oct-2010, KSHP05		

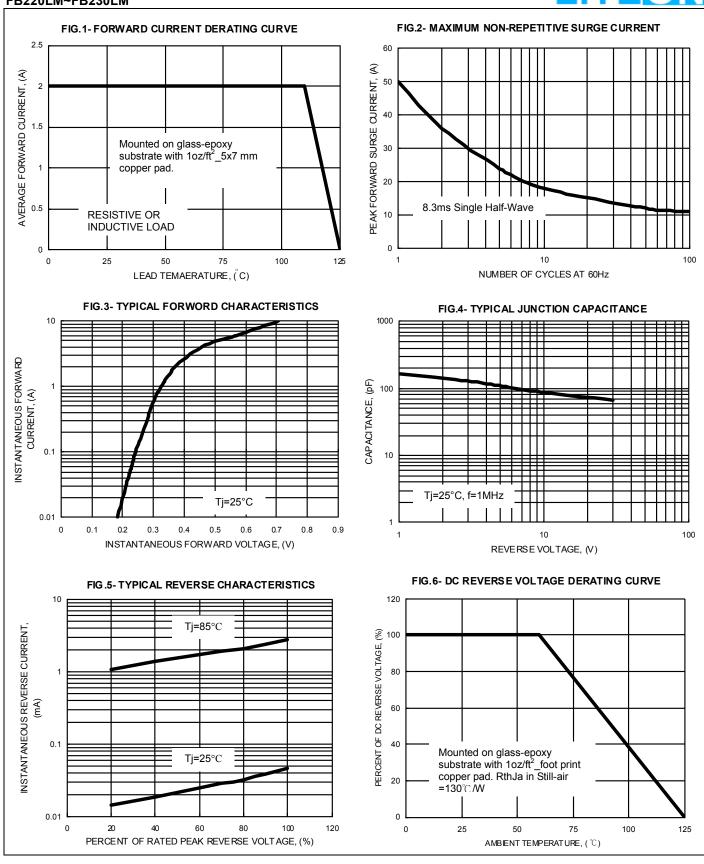
Note:

300us Pulse width, 2% Duty cycle.

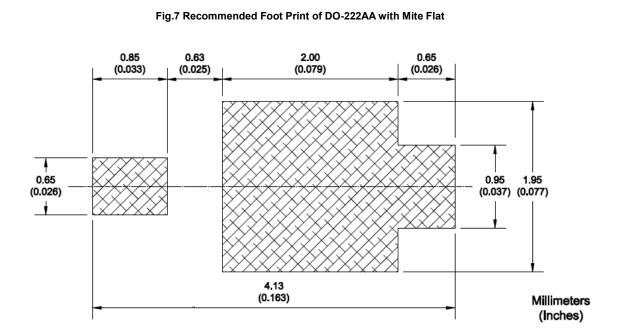
Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

Thermal Resistance test performed in accordance with JESD-51. Unit mounted on 0.75t glass-epoxy substrate with 5x7 mm copper pad. Real is measured at the lead of cathode band, $R_{^\theta JC}\;$ is measured at the top centre of body.











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